



[10191/1811]

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Inventor(s) : BREITSCHWERDT et al. Confirmation No.: 3071
Serial No. : 09/871,224
Filed : May 31, 2001
For : DEVICE AND METHOD FOR ETCHING A SUBSTRATE
BY USING AN INDUCTIVELY COUPLED PLASMA

Examiner : B. Tran

Art Unit : 1765

Customer No. : 26646

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450 Alexandria, VA 22313-1450, on

Date 9/5/03

Atty's Reg. # 41.172

Atty's Signature

Deris Magistre
DERVIS MAGISTRE
KENYON & KENYON

Mail-Stop Non-Fee Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

AMENDMENT TRANSMITTAL

SIR:

Please find an Amendment transmitted herewith for filing in the above-identified patent application.

No fee is believed to be required. However, if any fee is required, please use Deposit Account No. **11-0600**. A duplicate copy of this transmittal letter is enclosed for that purpose.

Respectfully submitted,

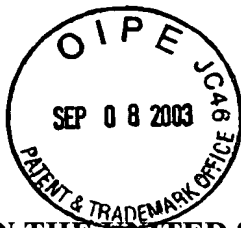
KENYON & KENYON

Dated: 9/5/03

By: *Richard L. Mayer*
Richard L. Mayer
Reg. No. 22,490

One Broadway
New York, NY 10004
(212) 425-7200

RECEIVED
SEP 12 2003
TC 1700



[10191/1811]

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Inventor(s) : BREITSCHWERDT et al. Confirmation No.: 3071
Serial No. : 09/871,224
Filed : May 31, 2001
For : DEVICE AND METHOD FOR ETCHING A SUBSTRATE BY
USING AN INDUCTIVELY COUPLED PLASMA

RECEIVED
SEP 12 2003
TC 1700

Examiner : B. Tran

Art Unit : 1765

Customer No. : 26646

I hereby certify that this correspondence is being deposited with
the United States Postal Service as first class mail in an envelope
addressed to: Commissioner for Patents, P.O. Box 1450
Alexandria, VA 22313-1450, on

Date 9/5/03 Atty's Reg. # 41,172

Atty's Signature

DERVIS MAGISTRE
KENYON & KENYON

Mail-Stop Non-Fee Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

AMENDMENT

SIR:

In response to the Office Action dated June 5, 2003, please amend the above-identified application as set forth below.

Amendments to the Specification do not appear in this paper.

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Amendments to the Drawings do not appear in this paper.

Remarks begin on page 5 of this paper.